# onsemi

## **MOSFET** - Power, Single N-Channel 100 V, 3.1 mΩ, 169 A

# NVMFWS003N10MC

#### Features

- Small Footprint (5x6 mm) for Compact Design
- Low R<sub>DS(on)</sub> to Minimize Conduction Losses
- Low Q<sub>G</sub> and Capacitance to Minimize Driver Losses
- AEC-Q101 Qualified and PPAP Capable
- Wettable Flank Product
- These Devices are Pb-Free, Halogen Free/BFR Free, Beryllium Free and are RoHS Compliant

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Parameter		Symbol	Value	Unit		
Drain-to-Source Voltage		V <sub>DSS</sub>	100	V		
Gate-to-Source Voltage		V <sub>GS</sub>	±20	V		
Continuous Drain		$T_{C} = 25^{\circ}C$	I <sub>D</sub>	169	Α	
Current $R_{\theta JC}$ (Note 1)	Steady	$T_{\rm C} = 100^{\circ}{\rm C}$		119		
Power Dissipation	State	$T_{C} = 25^{\circ}C$	PD	194	W	
$R_{\theta JC}$ (Note 1)		$T_{\rm C} = 100^{\circ}{\rm C}$		97		
Continuous Drain		T <sub>A</sub> = 25°C	۱ <sub>D</sub>	23.7	А	
Current R <sub>θJA</sub> (Notes 1, 2)	Steady State	T <sub>A</sub> = 100°C		16.8		
Power Dissipation		T <sub>A</sub> = 25°C	PD	3.8	W	
$R_{\theta JA}$ (Notes 1, 2)		$T_A = 100^{\circ}C$		1.9	1	
Pulsed Drain Current	$T_A = 25^{\circ}C$ , $t_p = 10 \ \mu s$		I <sub>DM</sub>	900	А	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	–55 to +175	°C		
Source Current (Body Diode)		۱ <sub>S</sub>	149	А		
Single Pulse Drain-to-Source Avalanche Energy ( $I_{L(pk)} = 11.9 \text{ A}$ )		E <sub>AS</sub>	1307	mJ		
Lead Temperature Soldering Reflow for Solder- ing Purposes (1/8" from case for 10 s)		ΤL	260	°C		

#### MAXIMUM RATINGS (T<sub>J</sub> = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

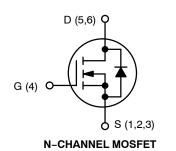
#### THERMAL RESISTANCE RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State (Note 1)	$R_{\theta JC}$	0.77	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	39	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using 1 in<sup>2</sup> pad size, 2 oz. Cu pad.

V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX
100 V	3.1 mΩ @ 10 V	169 A



MARKING DIAGRAM

ZZ = Lot Traceability

#### ORDERING INFORMATION

Device	Package	Shipping†
NVMFWS003N10MCT1G	DFNW5 (Pb-Free)	1500 / Tape & Reel

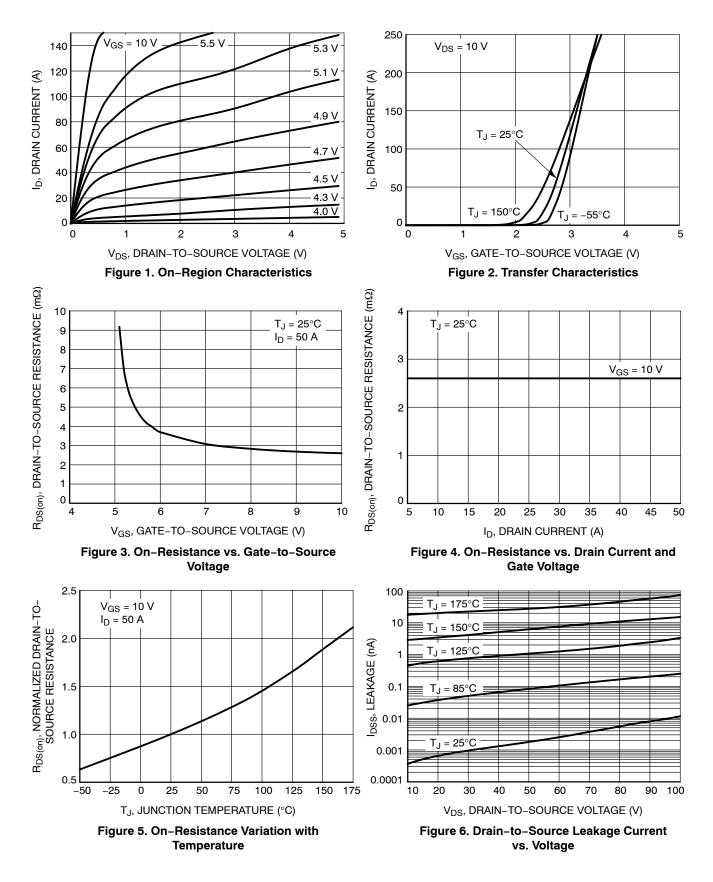
<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

### **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise specified)

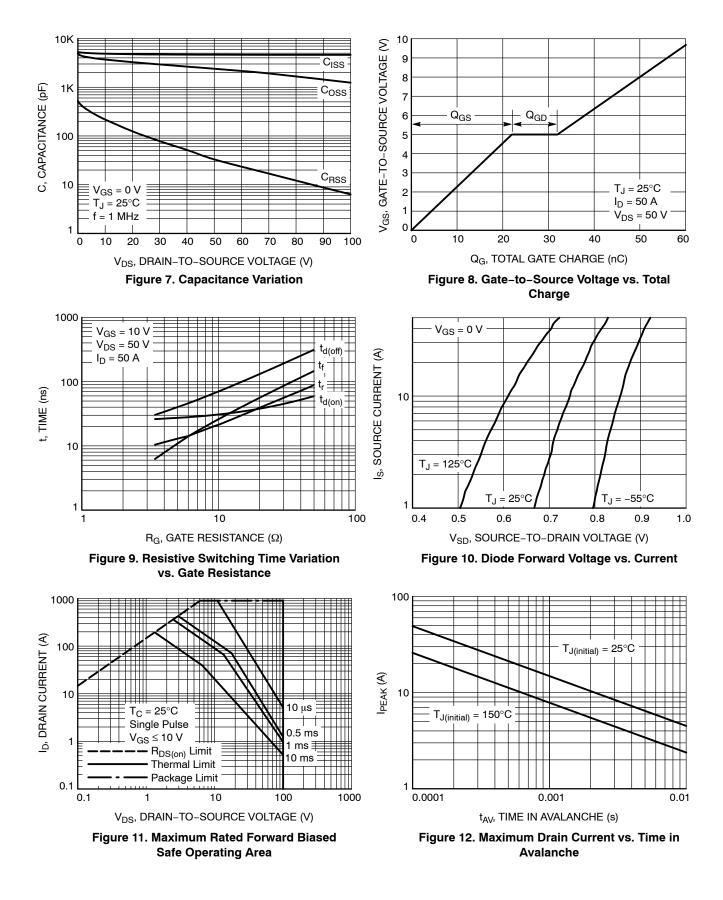
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS}$ = 0 V, I <sub>D</sub> = 250 $\mu$ A		100			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V <sub>(BR)DSS</sub> / T <sub>J</sub>	$I_D$ = 250 µA, ref to 25°C			50		mV/°C
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 100 V	$T_J = 25^{\circ}C$			1	μΑ
			T <sub>J</sub> = 125°C			100	-
Gate-to-Source Leakage Current	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS}$	= 20 V			100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> =	= 351 μA	2		4	V
Threshold Temperature Coefficient	V <sub>GS(TH)</sub> /T <sub>J</sub>	I <sub>D</sub> = 250 μA, ref to 25°C			-9.3		mV/°C
Drain-to-Source On Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 50 A			2.6	3.1	mΩ
Forward Transconductance	9FS	$V_{DS}$ = 10 V, I <sub>D</sub>	= 50 A		150		S
Gate-Resistance	R <sub>G</sub>	T <sub>A</sub> = 25°C			0.40		Ω
CHARGES & CAPACITANCES	•						
Input Capacitance	C <sub>ISS</sub>				4650		pF
Output Capacitance	C <sub>OSS</sub>	V <sub>GS</sub> = 0 V, f = 1 MHz, V <sub>DS</sub> = 50 V			2400		1
Reverse Transfer Capacitance	C <sub>RSS</sub>				33		1
Total Gate Charge	Q <sub>G(TOT)</sub>	V <sub>GS</sub> = 10 V, V <sub>DS</sub> = 50 V, I <sub>D</sub> = 50 A			62		nC
Threshold Gate Charge	Q <sub>G(TH)</sub>				14		-
Gate-to-Source Charge	Q <sub>GS</sub>				22		
Gate-to-Drain Charge	Q <sub>GD</sub>				10		
Plateau Voltage	V <sub>GP</sub>				5		V
SWITCHING CHARACTERISTICS (Note 3	3)						
Turn-On Delay Time	t <sub>d(ON)</sub>	$V_{GS}$ = 10 V, $V_{DS}$ = 50 V, I <sub>D</sub> = 50 A, R <sub>G</sub> = 6 $\Omega$			28		ns
Rise Time	tr				15		
Turn-Off Delay Time	t <sub>d(OFF)</sub>				46		
Fall Time	t <sub>f</sub>				14		
DRAIN-SOURCE DIODE CHARACTERIS	TICS						
Forward Diode Voltage	V <sub>SD</sub>	V <sub>GS</sub> = 0 V,	$T_J = 25^{\circ}C$		0.80	1.3	V
		$I_{\rm S} = 50 \rm A$	T <sub>J</sub> = 125°C		0.67		1
Reverse Recovery Time	t <sub>RR</sub>				72		ns
Reverse Recovery Charge	Q <sub>RR</sub>	V <sub>GS</sub> = 0 V, dI <sub>S</sub> /dt = 100 A/µs, I <sub>S</sub> = 31 A			91		nC
Charge Time	ta				34		ns
Discharge Time	t <sub>b</sub>				38		ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 3. Switching characteristics are independent of operating junction temperatures

#### **TYPICAL CHARACTERISTICS**



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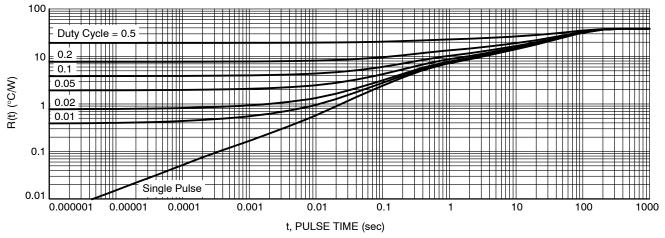
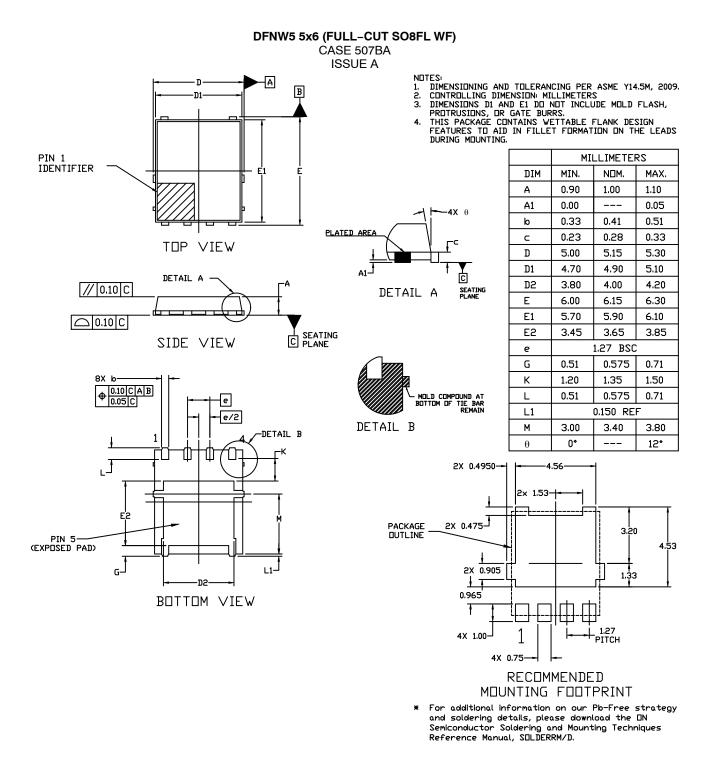


Figure 13. Transient Thermal Impedance

#### PACKAGE DIMENSIONS



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